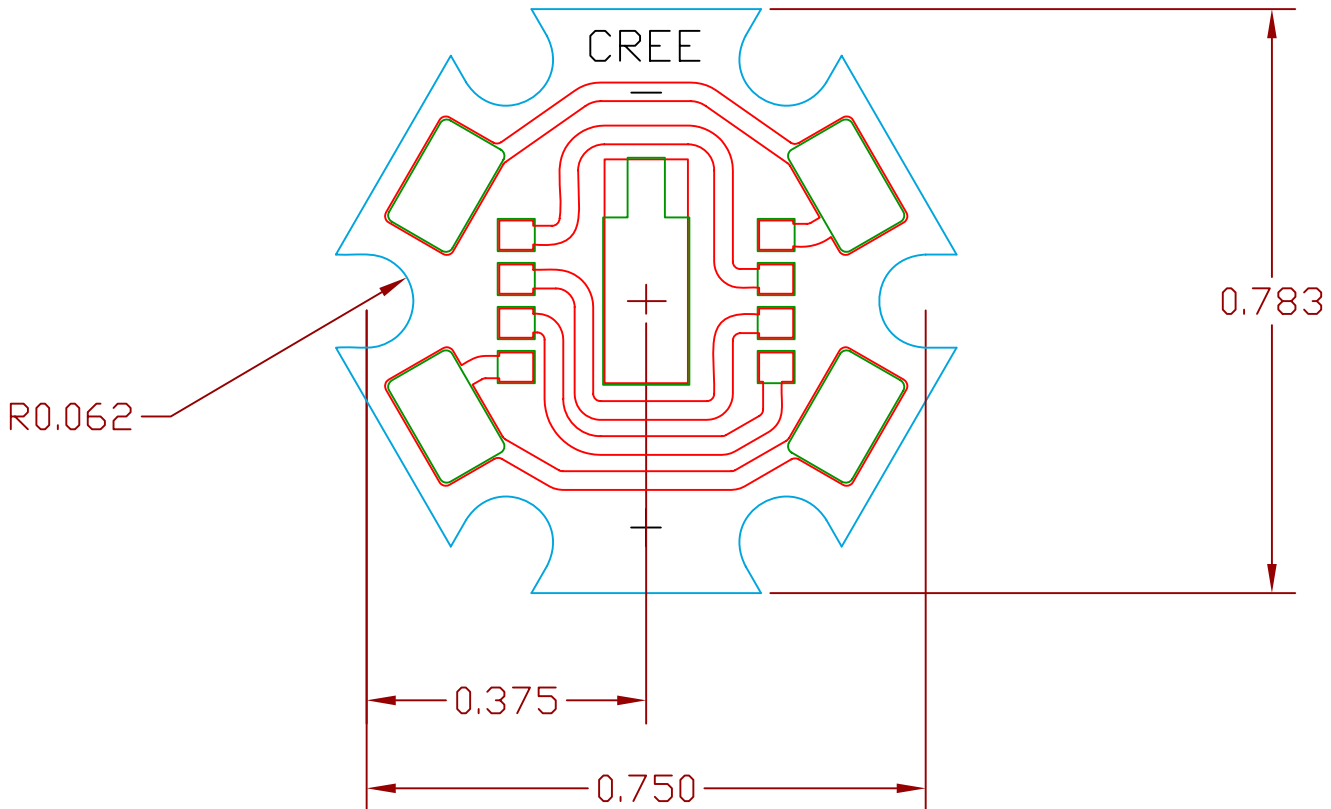
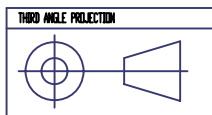


NOTICE
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NOTES:

1. Copper weight: 2-oz
2. Dielectric Thickness: 0.004" MAX.
3. Substrate:
Material: 0.080" 6061-T6
4. Holes: Drilled
5. Solder Mask Type: LPI, Thickness: 0.0003", Color: White
6. Pad Finish: Gold Plate



UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES & DECIMAL FRACTIONS TOLERANCES UNLESS SPECIFIED	JXX ± 0.01 XXX ± .005 " ± .01
FOR SHEET METAL PARTS ONLY	JXX ± .02 XXX ± .01 " ± .2

DRAWN BY R.Chaloupecky	DATE 04/15/07
CHECK	DATE
APPROVED	DATE
MATERIAL MCPCB (See Notes)	
FINAL PROTECTIVE FINISH	

		400 Silicon Drive Durham, NC 27703 Phone 919 581-0770
TITLE MCPCB - STAR 7090MC		
SIZE C	DRAWING NO. 2002-00017	REV. B
SCALE 4:1		SHEET 1 OF 1